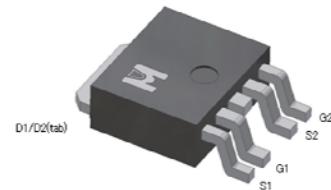
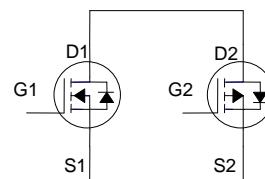


N & P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

	N-CH	P-CH
BV _{DSS}	40V	-40V
R _{DSON} (MAX.)	35mΩ	44mΩ
I _D	12A	-9A



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS		UNIT
Gate-Source Voltage		V_{GS}	N-CH	P-CH	V
			± 20	± 20	
Continuous Drain Current	$T_c = 25^\circ\text{C}$	I_D	12	-9	A
	$T_c = 100^\circ\text{C}$		8	-6	
Pulsed Drain Current ¹		I_{DM}	48	-36	
Power Dissipation	$T_c = 25^\circ\text{C}$	P_D	21		W
	$T_c = 100^\circ\text{C}$		8.3		
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	R_{0JC}		6	°C / W
Junction-to-Ambient	R_{0JA}		42	

¹Pulse width limited by maximum junction temperature.

²Duty cycle ≤ 1%

ELECTRICAL CHARACTERISTICS ($T_c = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	N-CH	40		V
		$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	P-CH	-40		
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	N-CH	1.8	2.3	3.2
		$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	P-CH	-1.8	-2.3	-3.2
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$	N-CH			± 100
		$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$	P-CH			± 100
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 32\text{V}, V_{\text{GS}} = 0\text{V}$	N-CH			1
		$V_{\text{DS}} = -32\text{V}, V_{\text{GS}} = 0\text{V}$	P-CH			-1
		$V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$	N-CH			25
		$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$	P-CH			-25
On-State Drain Current ¹	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} = 5\text{V}, V_{\text{GS}} = 10\text{V}$	N-CH	12		A
		$V_{\text{DS}} = -5\text{V}, V_{\text{GS}} = -10\text{V}$	P-CH	-9		
Drain-Source On-State Resistance ¹	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 10\text{V}, I_D = 10\text{A}$	N-CH		30	35
		$V_{\text{GS}} = -10\text{V}, I_D = -8\text{A}$	P-CH		38	44
		$V_{\text{GS}} = 7\text{V}, I_D = 8\text{A}$	N-CH		40	50
		$V_{\text{GS}} = -7\text{V}, I_D = -6\text{A}$	P-CH		50	70
Forward Transconductance ¹	g_{fs}	$V_{\text{DS}} = 5\text{V}, I_D = 10\text{A}$	N-CH		19	S
		$V_{\text{DS}} = -5\text{V}, I_D = -8\text{A}$	P-CH		11	
DYNAMIC						
Input Capacitance	C_{iss}	$N\text{-CH}$ $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 20\text{V}, f = 1\text{MHz}$ $P\text{-CH}$ $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -20\text{V}, f = 1\text{MHz}$	N-CH		515	pF
			P-CH		745	
Output Capacitance	C_{oss}		N-CH		77	
			P-CH		78	
Reverse Transfer Capacitance	C_{rss}		N-CH		53	
			P-CH		58	

Total Gate Charge ^{1,2}	Q_g	N-CH $V_{DS} = 20V, V_{GS} = 10V,$ $I_D = 15A$ P-CH $V_{DS} = -20V, V_{GS} = -10V,$ $I_D = -10A$	N-CH		13.1		nC
Gate-Source Charge ^{1,2}	Q_{gs}		P-CH		11.5		
Gate-Drain Charge ^{1,2}	Q_{gd}		N-CH		1.9		
Turn-On Delay Time ^{1,2}	$t_{d(on)}$		P-CH		2.5		
Rise Time ^{1,2}	t_r		N-CH		4.1		
Turn-Off Delay Time ^{1,2}	$t_{d(off)}$		P-CH		2.8		
Fall Time ^{1,2}	t_f	N-CH $V_{DS} = 10V,$ $I_D = 1A, V_{GS} = 10V, R_{GS} = 6\Omega$ P-CH $V_{DS} = -10V,$ $I_D = -1A, V_{GS} = -10V, R_{GS} = 6\Omega$	N-CH		2.5		nS
			P-CH		7		
			N-CH		7.5		
			P-CH		10		
			N-CH		12		
			P-CH		20		
		N-CH $I_D = -1A, V_{GS} = -10V, R_{GS} = 6\Omega$	N-CH		4		V
			P-CH		12		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_c = 25^\circ C$)

Continuous Current	I_S	$I_F = I_S, V_{GS} = 0V$	N-CH			12	A	
Pulsed Current ³	I_{SM}		P-CH			-9		
Forward Voltage ¹	V_{SD}		N-CH			48	V	
			P-CH			-36		

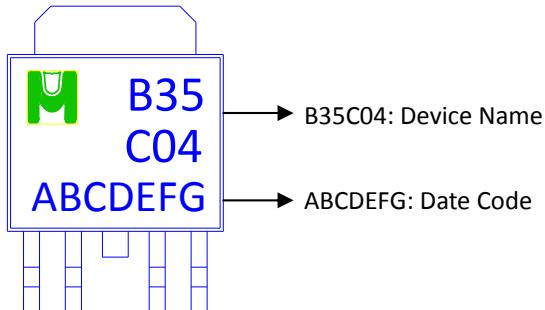
¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

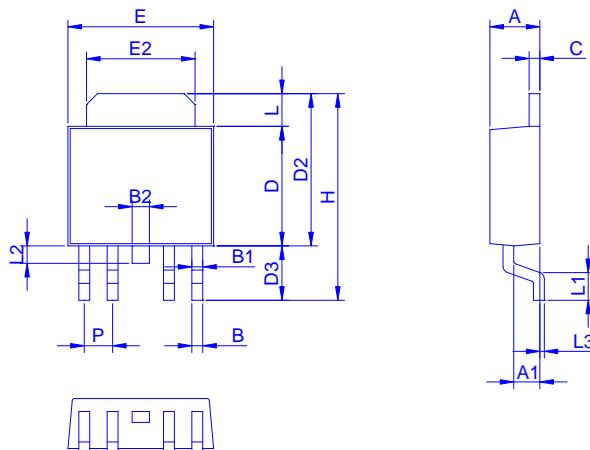
³Pulse width limited by maximum junction temperature.

Ordering & Marking Information:

Device Name: EMB35C04A for DPAK (TO-252)

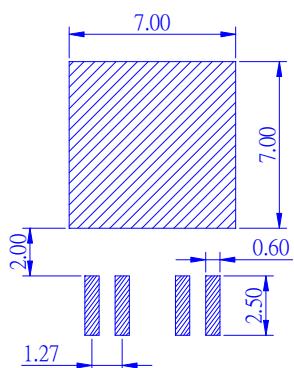


Outline Drawing

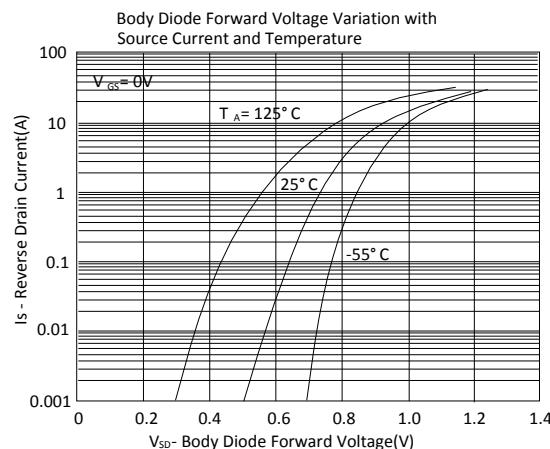
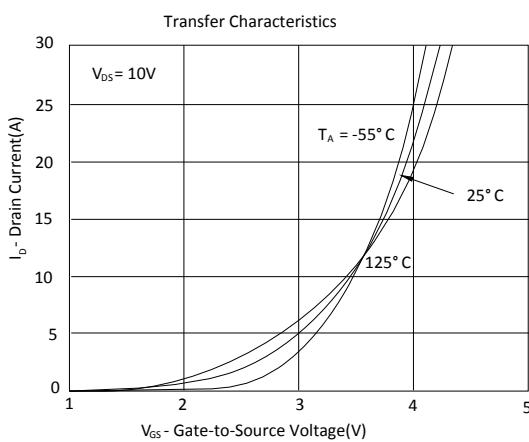
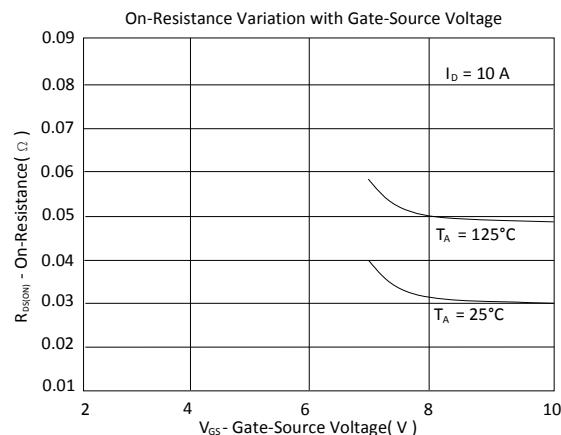
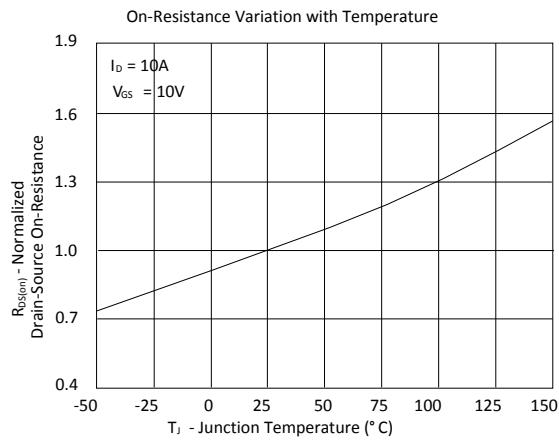
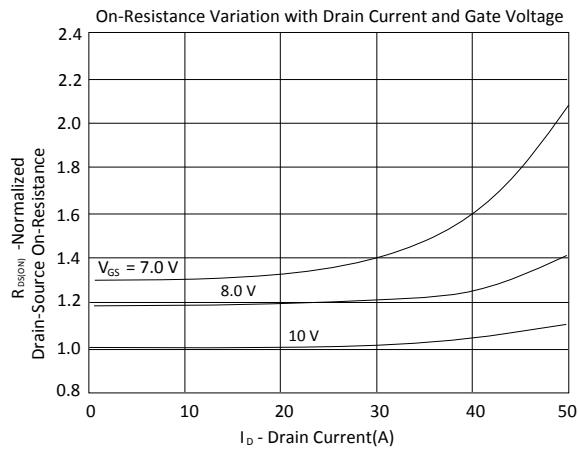
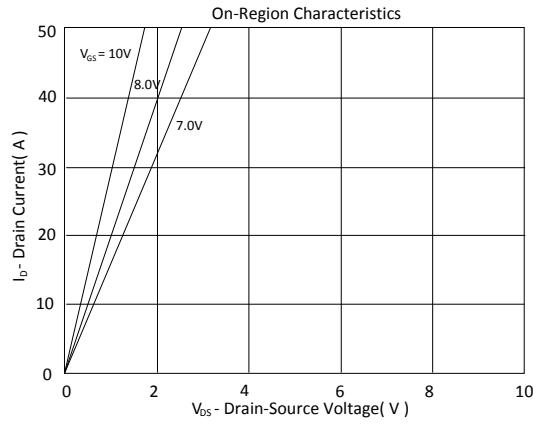


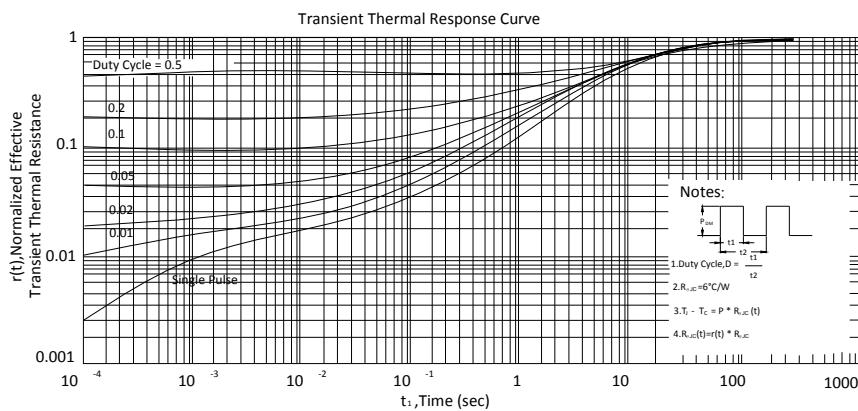
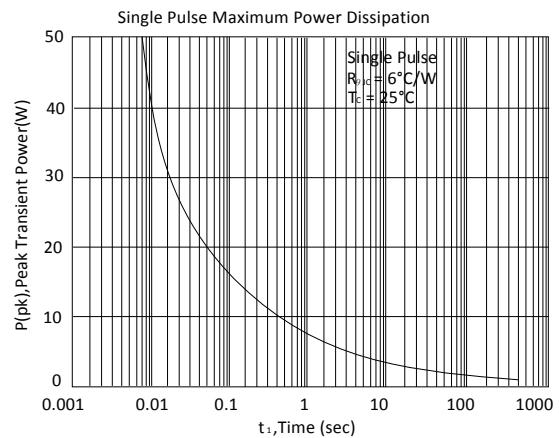
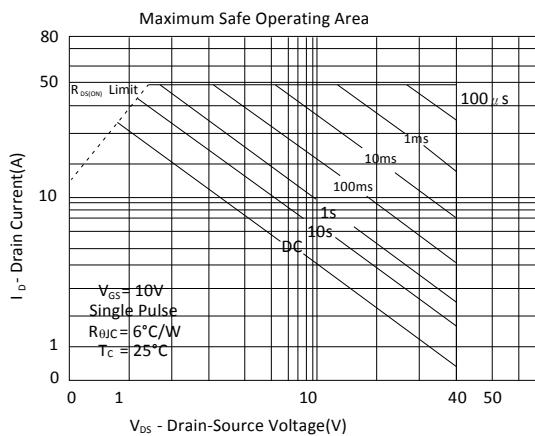
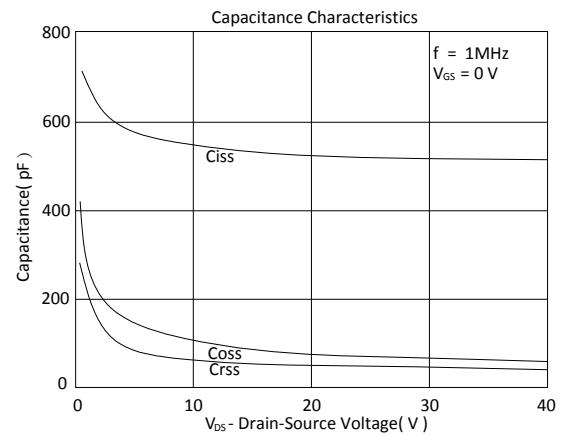
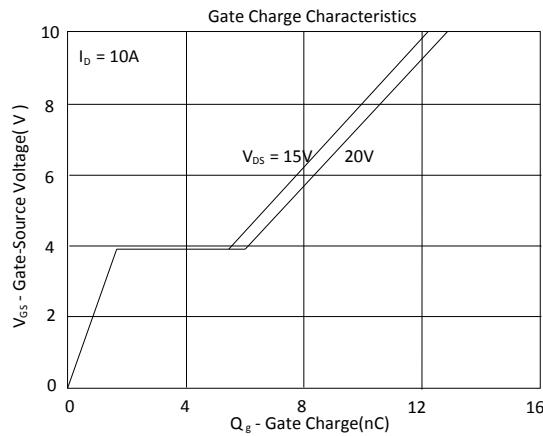
Dimension	A	A1	B	B1	B2	C	D	D2	D3	E	E2	H	L	L1	L2	L3	P
Min.	2.10	1.10	0.30	0.55	0.40	0.40	5.30	6.70	2.20	6.30	4.80	9.20	1.30	0.90	0.50	0.00	1.17
Max.	2.50	1.30	0.70	0.75	0.80	0.60	5.70	7.30	3.00	6.70	5.45	10.15	1.70	1.50	1.10	0.30	1.37

Footprint



N-Channel





P-Channel

